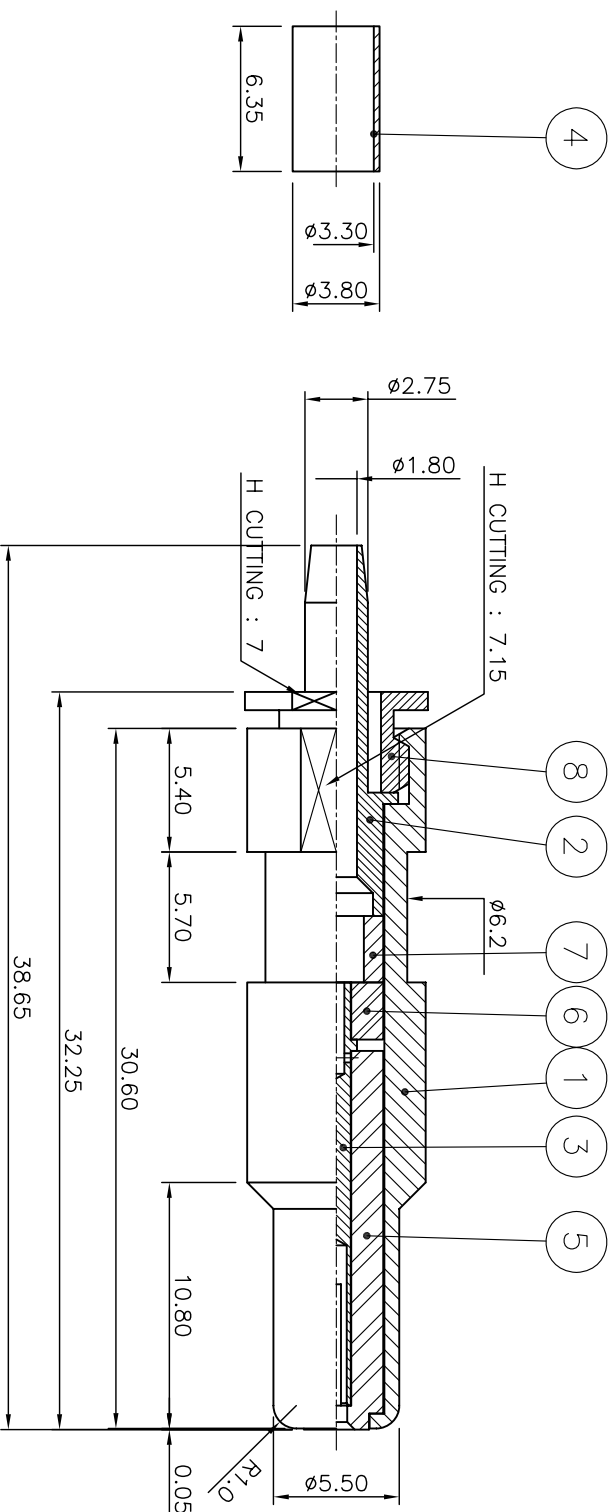


REVISION			
REV	DESCRIPTION	DRAWN	APPR
1/R	초도작성	E.H.KIM	I.C.KIM
			2012.10.24



8	BACK NUT	1	MBsBD	Gold Plate	DBN00183-5/1
7	INSERT	1	MBsBD	Gold Plate	DIS00189-5/1
6	INSULATOR	1	TEFLON		DIN02089-N/1
5	INSULATOR	1	TEFLON		DIN02094-N/1
4	FERRULE	1	MBsBD	Gold Plate	DFE00169-5/1
3	CONTACT	1	BeCu	Gold Plate	DCT02692-5/1
2	BODY	1	MBsBD	Gold Plate	DBD03180-5/1
1	BODY	1	MBsBD	Gold Plate	DBD03182-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE	KJ COMTECH CO.,LTD. RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle	2012. 10. 24		
±0.2		APPROVED BY	I. C. KIM	
±1°		CHECKED BY		
MATERIAL	-	DRAWN BY	E. H. KIM	
FINISH	-	SCALE	3/1	UNIT
			mm	
		A4	DWG NO.	CN02882-7/1
			REVISION	1
			SHEET	1 of 1

TITLE
기타 CABLE PS Crimp 점접촉림체(발칸)